

HFA15PB60PbF

Ultrafast, Soft Recovery Diode

Features

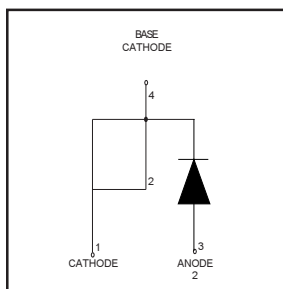
- Ultrafast Recovery
- Ultrasoft Recovery
- Very Low I_{RRM}
- Very Low Q_{rr}
- Specified at Operating Conditions
- Lead-Free

Benefits

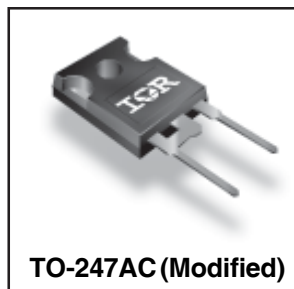
- Reduced RFI and EMI
- Reduced Power Loss in Diode and Switching Transistor
- Higher Frequency Operation
- Reduced Snubbing
- Reduced Parts Count

Description

International Rectifier's HFA15PB60 is a state of the art ultra fast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 600 volts and 15 amps continuous current, the HFA15PB60 is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultra fast recovery time, the HEXFRED product line features extremely low values of peak recovery current (I_{RRM}) and does not exhibit any tendency to "snap-off" during the t_b portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED HFA15PB60 is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.



$V_R = 600V$
$V_F(\text{typ.})^* = 1.3V$
$I_{F(AV)} = 15A$
$Q_{rr}(\text{typ.}) = 80nC$
$I_{RRM}(\text{typ.}) = 4.0A$
$t_{rr}(\text{typ.}) = 19ns$
$di_{(rec)M}/dt(\text{typ.})^* = 160A/\mu s$



Absolute Maximum Ratings

	Parameter	Max	Units
V_R	Cathode-to-Anode Voltage	600	V
$I_F @ T_C = 100^\circ C$	Continuous Forward Current	15	A
I_{FSM}	Single Pulse Forward Current	150	
I_{FRM}	Maximum Repetitive Forward Current	60	
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	74	W
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	29	
T_J	Operating Junction and	-55 to +150	C
T_{STG}	Storage Temperature Range		

* 125°C

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Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min	Typ	Max	Units	Test Conditions
V _{BR}	Cathode Anode Breakdown Voltage	600			V	I _R = 100μA
V _{FM}	Max Forward Voltage		1.3	1.7	V	I _F = 15A
			1.5	2.0		I _F = 30A
			1.2	1.6		I _F = 15A, T _J = 125°C
I _{RM}	Max Reverse Leakage Current		1.0	10	μA	V _R = V _R Rated
			400	1000		T _J = 125°C, V _R = 0.8 x V _R Rated
C _T	Junction Capacitance		25	50	pF	V _R = 200V
L _S	Series Inductance		12		nH	Measured lead to lead 5mm from package body

Dynamic Recovery Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min	Typ	Max	Units	Test Conditions	
t _{rr}	Reverse Recovery Time		19		ns	I _F = 1.0A, di _F /dt = 200A/μs, V _R = 30V	
t _{rr1}	See Fig. 5, 10		42	60			T _J = 25°C
t _{rr2}			74	120			T _J = 125°C
I _R RM1	Peak Recovery Current		4.0	6.0	A	T _J = 25°C	
			6.5	10			T _J = 125°C
Q _{rr1}	Reverse Recovery Charge		80	180	nC	T _J = 25°C	
			220	600			T _J = 125°C
di _{(rec)M} /dt1	Peak Rate of Fall of Recovery Current		188		A/μs	di _F /dt = 200A/μs	
di _{(rec)M} /dt2	During t _b See Fig. 8		160				T _J = 125°C

Thermal - Mechanical Characteristics

	Parameter	Min	Typ	Max	Units
T _{lead} ①	Lead Temperature			300	°C
R _{thJC}	Thermal Resistance, Junction to Case			1.7	K/W
R _{thJA} ②	Thermal Resistance, Junction to Ambient			40	
R _{thCS} ③	Thermal Resistance, Case to Heat Sink		0.25		
Wt	Weight		6.0		g
				0.21	(oz)
	Mounting Torque	6.0		12	Kg-cm
		5.0		10	lbf•in

① 0.063 in. from Case (1.6mm) for 10 sec

② Typical Socket Mount

③ Mounting Surface, Flat, Smooth and Greased

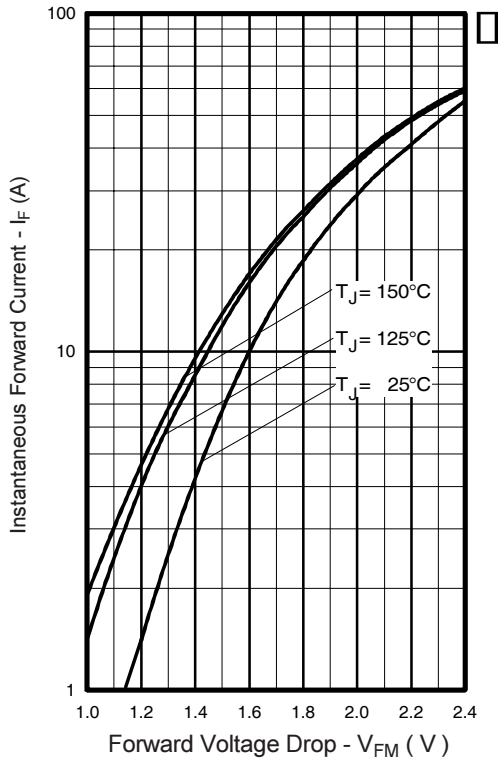


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

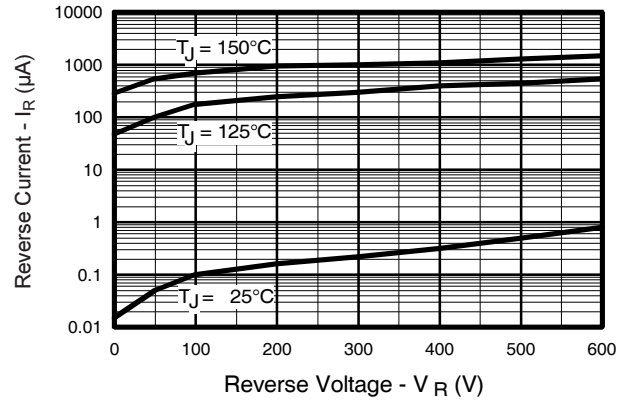


Fig. 2 - Typical Reverse Current vs. Reverse Voltage

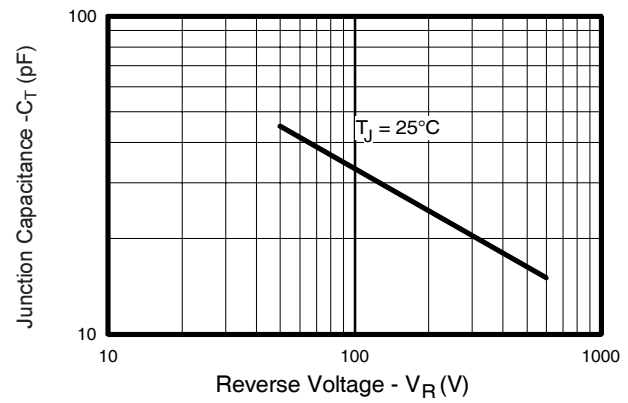


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

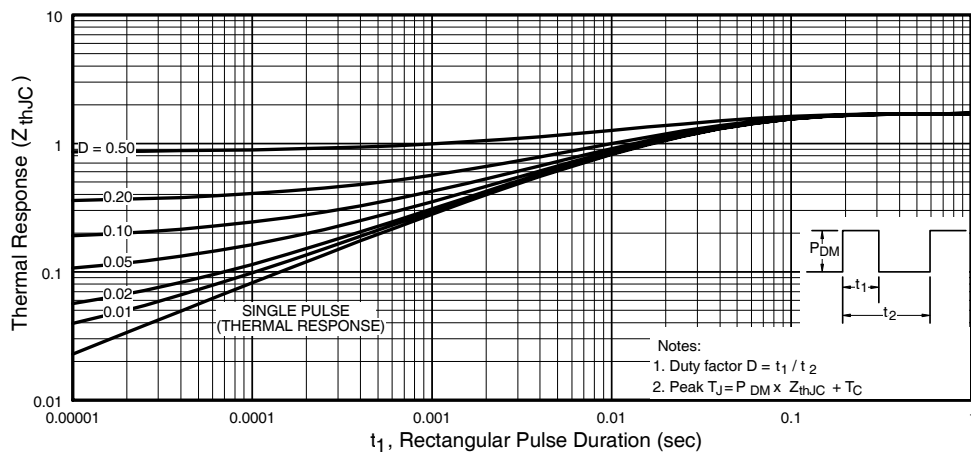


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

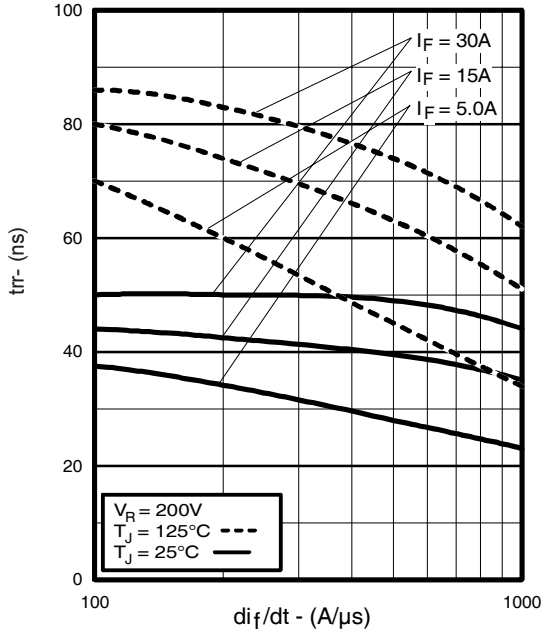


Fig. 5 - Typical Reverse Recovery Time vs. di_f/dt

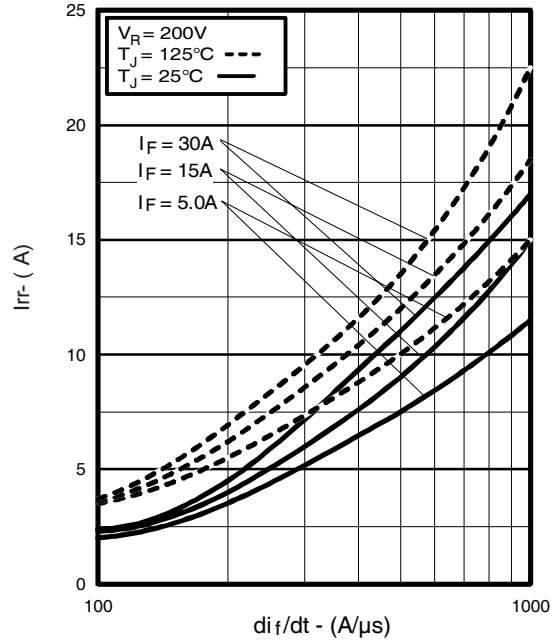


Fig. 6 - Typical Recovery Current vs. di_f/dt

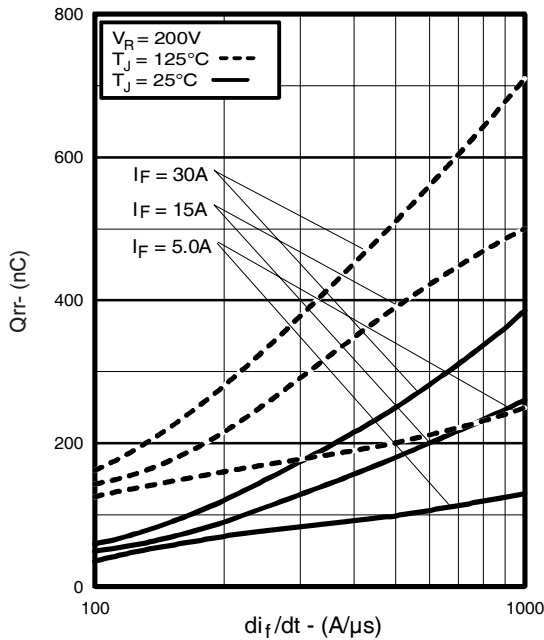


Fig. 7 - Typical Stored Charge vs. di_f/dt

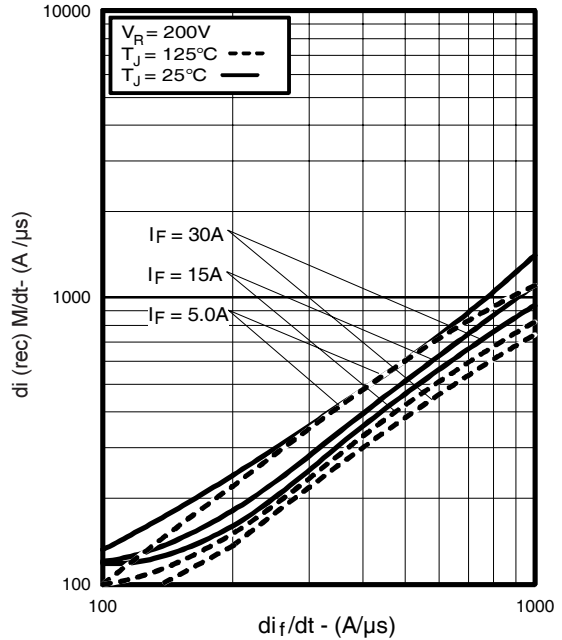


Fig. 8 - Typical $di_{(rec)}M/dt$ vs. di_f/dt

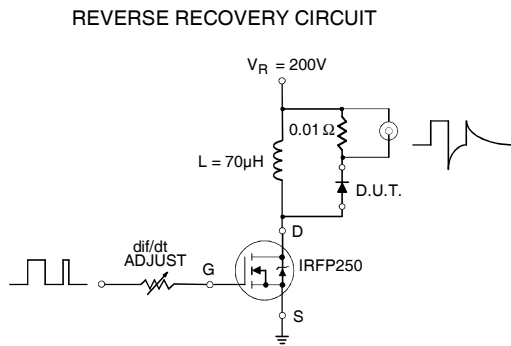


Fig. 9 - Reverse Recovery Parameter Test Circuit

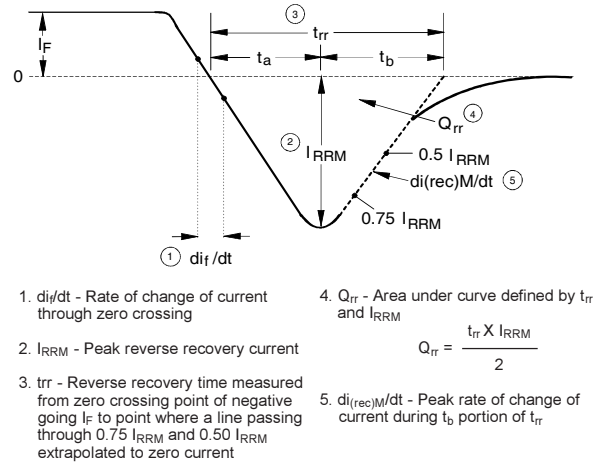
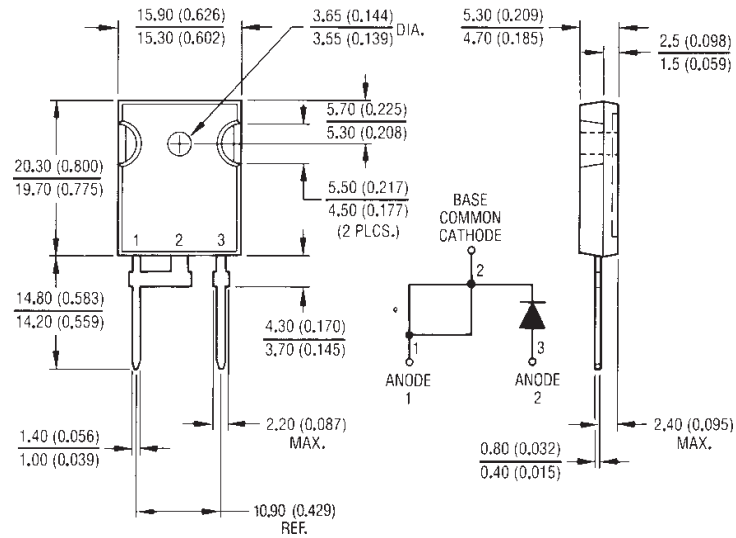


Fig. 10 - Reverse Recovery Waveform and Definitions

HFA15PB60PbF

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Conforms to JEDEC Outline TO-247AC MODIFIED
Dimensions in millimeters and inches

Note: Marking "P" indicates Lead-Free

Data and specifications subject to change without notice.

International
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